	Docket No.: XA-9880		
FORM PTO-1595 (Modified) 06 - 11 - 20	0.3 HEET U.S. DEPARTMENT OF COMMERCE		
(Nev. 0.3-01) CAR No. 0651 0027 (avo 5/21/2002)	– Patent and Trademark Offic		
Tab settings	the attached original documents or copy thereof.		
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):		
Shimpei TSUJIKAWA, Toshiyuki MINE, Jiro YUGAMI,			
Natsuki YOKOYAMA, Tsuyoshi YAMAUCHI ノ ク 入?	Name: Hitachi, Ltd.		
6.3.03	Address: 6, Kanda Surugadai 4-chome		
Additional names(s) of conveying party(ies)	• • • • • • • • • • • • • • • • • • •		
3. Nature of conveyance:			
🛛 Assignment 🔲 Merger			
Security Agreement     Change of Name	City: Chiyoda-ku State/Prov.: Tokyo		
Other	Country: JAPAN ZIP:		
Execution Date: <u>4/18/03, 4/10/03, 4/21/03, 4/10/03, 4/10/03</u>	Additional name(s) & address(es) 🛛 Yes 🗔 No		
4. Application number(s) or patent numbers(s):			
If this document is being filed together with a new application	4/18/03, $4/10/03$ , $4/21/03$ , a, the execution date of the application is: $4/10/03$ , $4/10/03$		
Patent Application No. Filing date	B. Patent No.(s)		
06/04/2003 KZEWDIE 00000030 10452126 01 FC:8021 40.00 IP Additional numbers 5. Name and address of party to whom correspondence concerning document should be mailed:	Yes X No 6. Total number of applications and patents involved: 1		
Name: Mitchell W. Shapiro	7. Total fee (37 CFR 3.41):\$ 40.00		
Registration No. 31,568	Enclosed - Any excess or insufficiency should be		
Address: Miles & Stockbridge P.C.	credited or debited to deposit account		
1751 Pinnacle Dr., Suite 500	Authorized to be charged to deposit account		
	8. Deposit account number:		
City: McLean State/Prov.: VA	50-1165		
Country: U.S. ZIP: 22102-3833	(Attach duplicate copy of this page if paying by deposit account)		
DO NOT	USE THIS SPACE		
9. Statement and signature. To the best of my knowledge and belief, the foregoing inform of the original document.	nation is true and correct and any attached copy is a true copy		
Mitchell W. Shapiro	June 3, 2003		
Name of Person Signing Total number of pages including	Signature Date 3		
	th required cover sheet information to: Trademarks, Box Assignments <b>PATENT</b>		

REEL: 014142 FRAME: 0355

## RECORDATION FORM COVER SHEET CONTINUATION PATENTS ONLY

U.S. Department of Commerce Patent and Trademark Office PATENT

Conveying		s attached	
	I Conveying Parties	Execution Date Month Day Year	
Name (line 1)			
Name (line 2)	15°	Execution Date	
Name (line 1)	44c	Month Day Year	
Name (line 2)		Execution Date	
Name (line 1)		Month Day Year	
Name (line 2)			
Receiving P	Party Mark if additional names of re	ceiving parties attached	
-	Hitachi ULSI Systems Co., Ltd.	If document to be recorded	
Name (line 2)		is an assignment and the receiving party is not domiciled in the United	
		States, an appointment of a domestic representative is attached.	
Address (line 1)	22-1, Josuihoncho 5-chome	(Designation must be a separate document from Assignment.)	
Address (line 2)	Kodaira-shi	, congrimenty	
Address (line 3)			
<b>.</b>	City State/Country Zip Code	If document to be recorded	
Name (line 1)		is an assignment and the receiving party is not	
Name (line 2)		domiciled in the United States, an appointment of a domestic	
Address (line 1)		representative is attached. (Designation must be a separate document from	
Address (line 2)		Assignment.)	
Address (line 3)			
	City State/Country Zip Code		
Application Number(s) or Patent Number(s) Mark if additional numbers attached			
	te Patent Application Number or the Patent Number (DO NOT ENTER BOTH numbers for the set tent Application Number(s) Patent Numb		
L		] []	

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## ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan b Hitachi, Ltd.,

and Hitachi ULSI Systems Co., Ltd.,

corporations organized under the laws of Japan,

located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan,

and Josuihoncho 5-chome, Kodaira-shi, Tokyo, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd.,

and Hitachi ULSI Systems Co., Ltd.,

their successors and assigns, all my right, title and interest, in and for the United States of America, in and to

## SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THEREOF

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi, Ltd., and Hitachi ULSI Systems Co., Ltd.,

their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd., and Hitachi ULSI Systems Co., Ltd.,

Signed on the date(s) indicated aside our signatures:

Date Signed INVENTOR(S) (発明者フルネームサイン) (署名日) 4/18, 2003 atsuni 4/10/2003 Tsuyoshi Tamanchi 6) \_\_\_\_\_ 7) 8) 9) 10) PATENT

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**RECORDED: 06/03/2003**